

Design and Development of an Event-driven SOI Pixel Detector for X-ray Astronomy



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SOIPIX for X-ray Astronomy

We have been developing monolithic active pixel detectors based on the SOIPIX for future X-ray astronomical satellite missions (e.g. FORCE). The performance is required ...

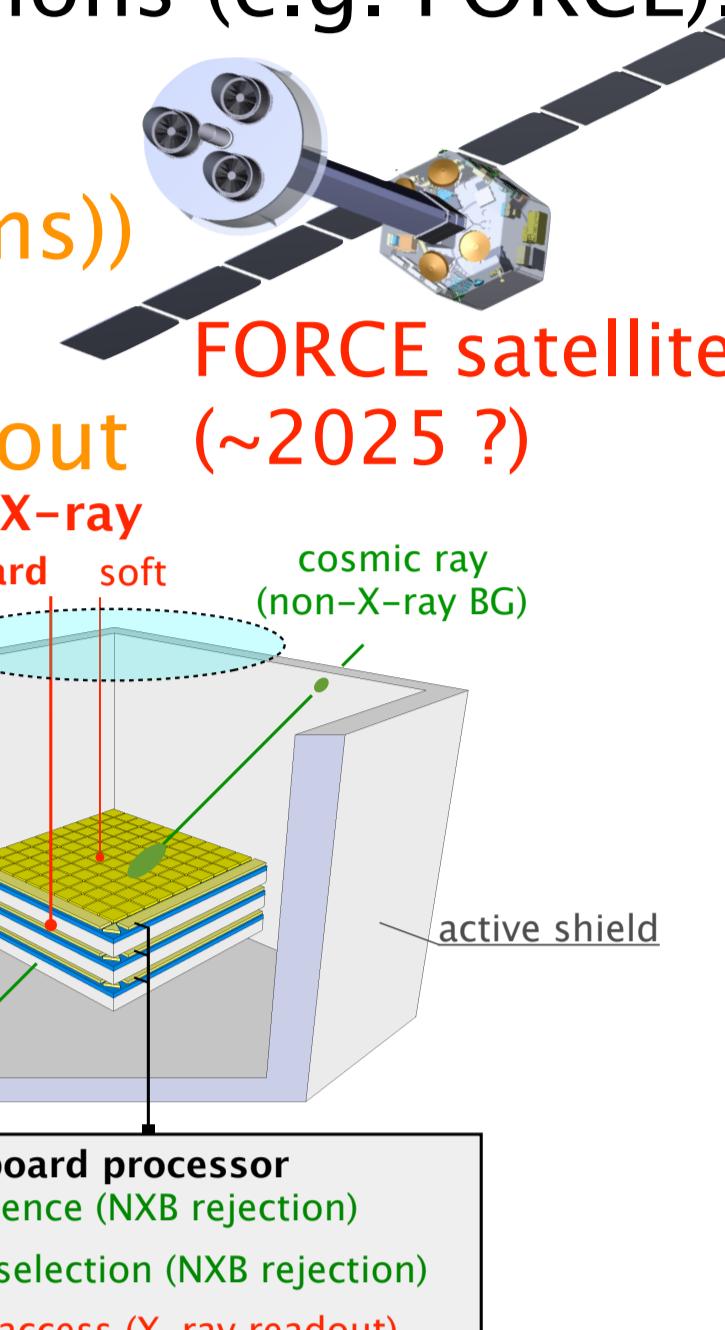
- FWHM ≤ 140 eV @ 6 keV (Readout Noise ≤ 10 e⁻ (rms))
- Spatial resolution : ≤ 100 μm pitch pixel
- Coincidence time resolution : ~ 10 μs per event readout
- Wide energy range : 0.5 – 40 keV

-> We have been developing "XRPIX device."

Event-driven Readout mode

We realize the spectroscopic system on the right figure.

(anti-coincidence method between hit signals and external active shield detectors)

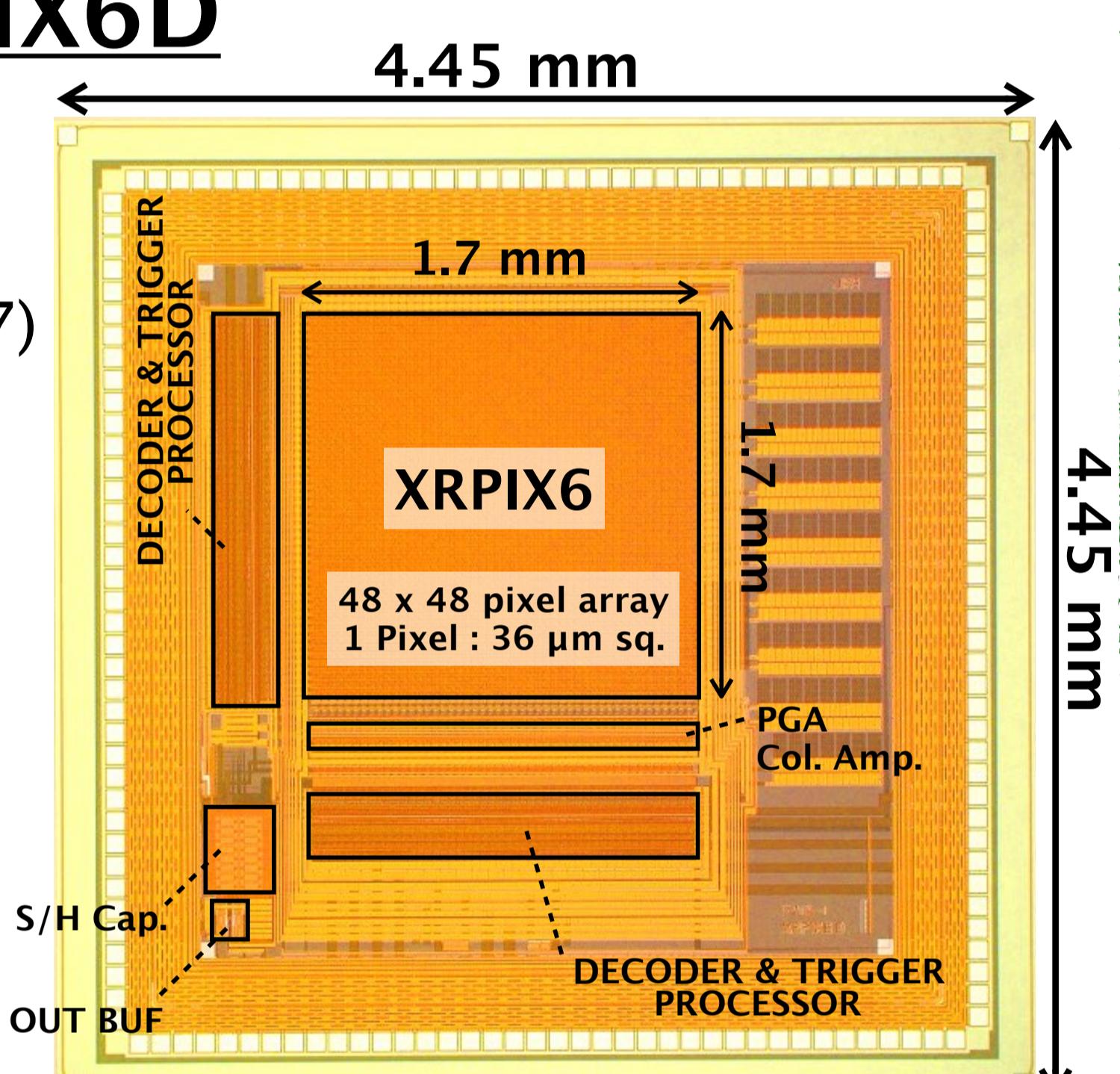


Design Specification of XRPIX6D

XRPIX6D is the new prototype for improving spectroscopic performance by introducing Double-SOI structure. (Fabricated Jan., 2017)

Components

- Chip Size : 4.45 mm sq. (Effective Area : 1.7 mm sq.)
- Pixel Size : 36 μm sq.
- # of Pixel : 48 x 48 (= ~2.3k)
- Thickness of Sensor Layer : ~ 300 μm
- Sensor Wafer : $\sim 1\text{k}\Omega \text{ cm}$ (PCZ wafer)
* Double-SOI wafer



Our Works with XRPIX

We have designed 8 devices and shown some basic performances.

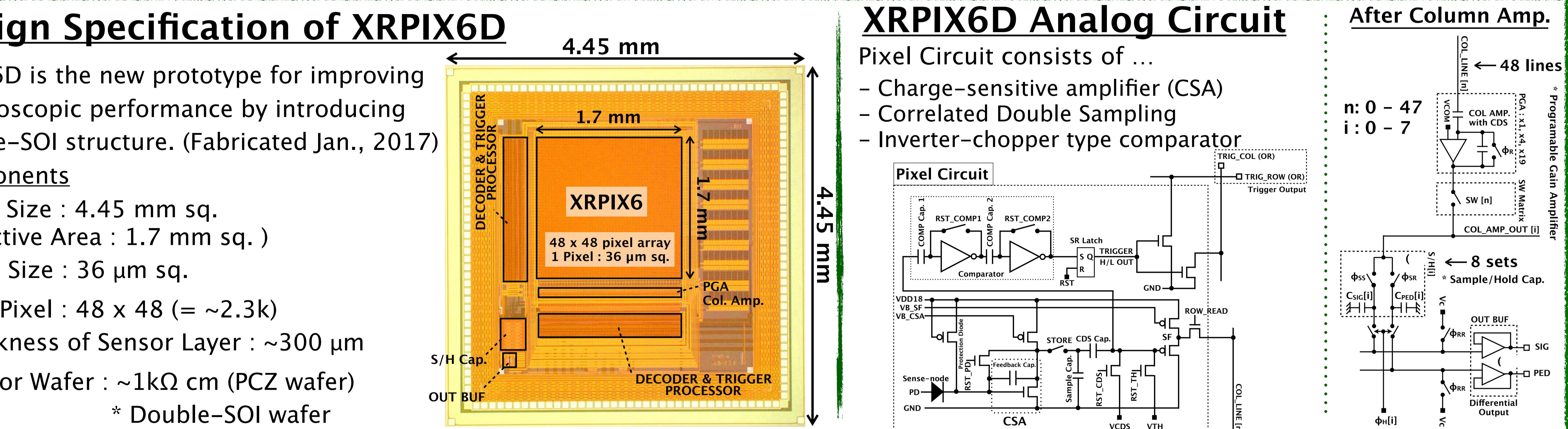
- X-ray response of XRPIX (SOIPIX) -> XRPIX1/1b [1], [2]
- Dependency on pixel size and structure -> XRPIX2 [3]
- Event-driven readout mode -> XRPIX1b [4], XRPIX2b [5]
- Improvement of Spectroscopic Performance -> XRPIX3b [6]
- Large-area Device -> XRPIX5 (H. Hayashi's poster presentation)

The basic function of XRPIX has been already realized.

Recently, we showed that increasing the conversion gain of the sense-node is effective for improving the spectroscopic performance [6].

→ We applied a new approach to the XRPIX device.

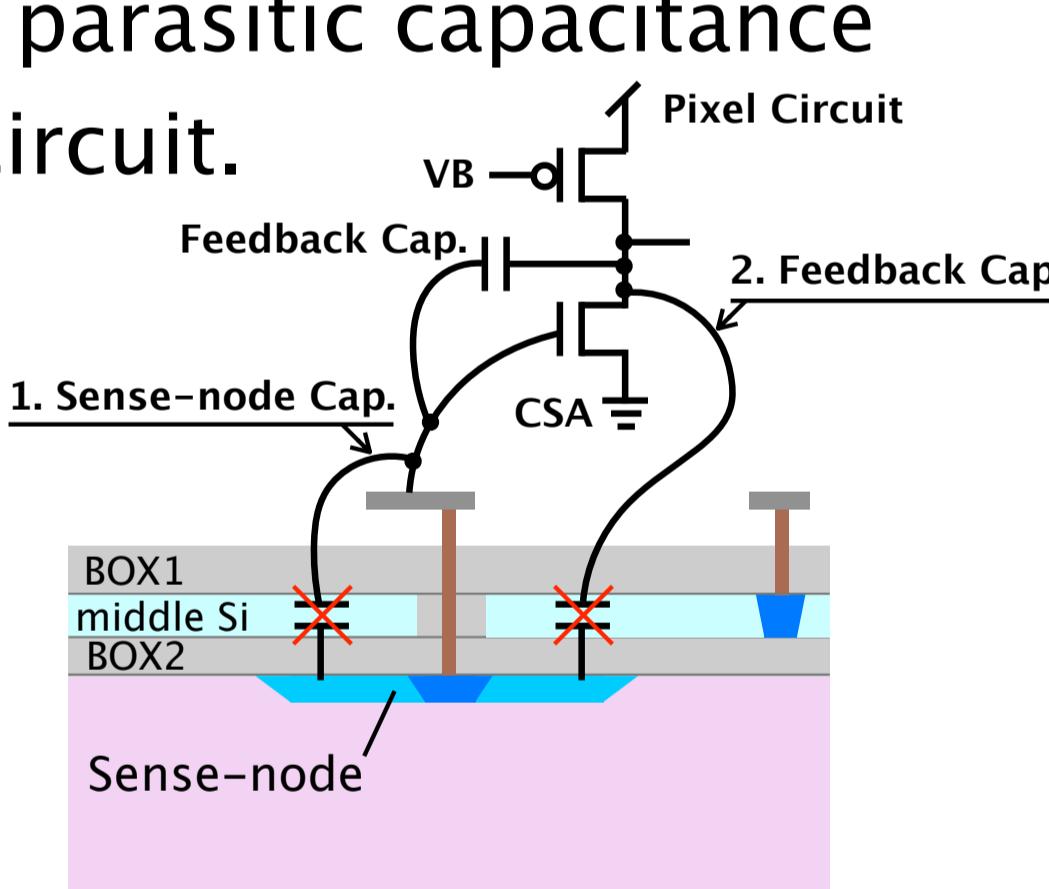
Our New Device -> "XRPIX6D"



Introduction of Double-SOI Structure

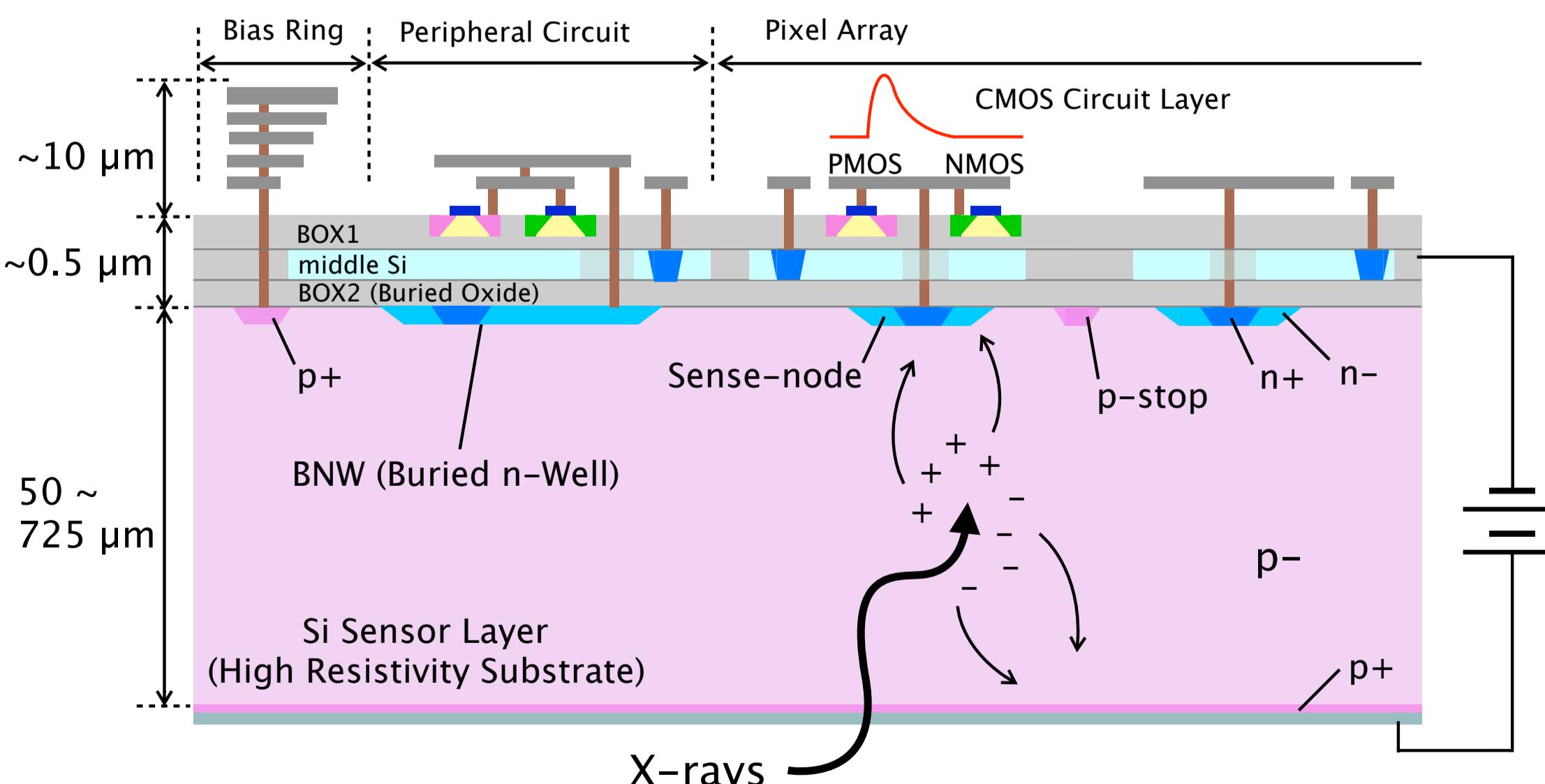
The Double-SOI structure reduce parasitic capacitance between sense-node and CMOS circuit.

1. Sense-node Capacitance
-> Increase conversion gain
2. Feedback Capacitance
-> Increase closed loop gain



The spectroscopic performance improves by increasing the sense-node gain [6].

Therefore, we introduced Double-SOI structure at XRPIX6D. Furthermore, Double-SOI structure can suppress electrical crosstalk between sense-node and CMOS circuit.



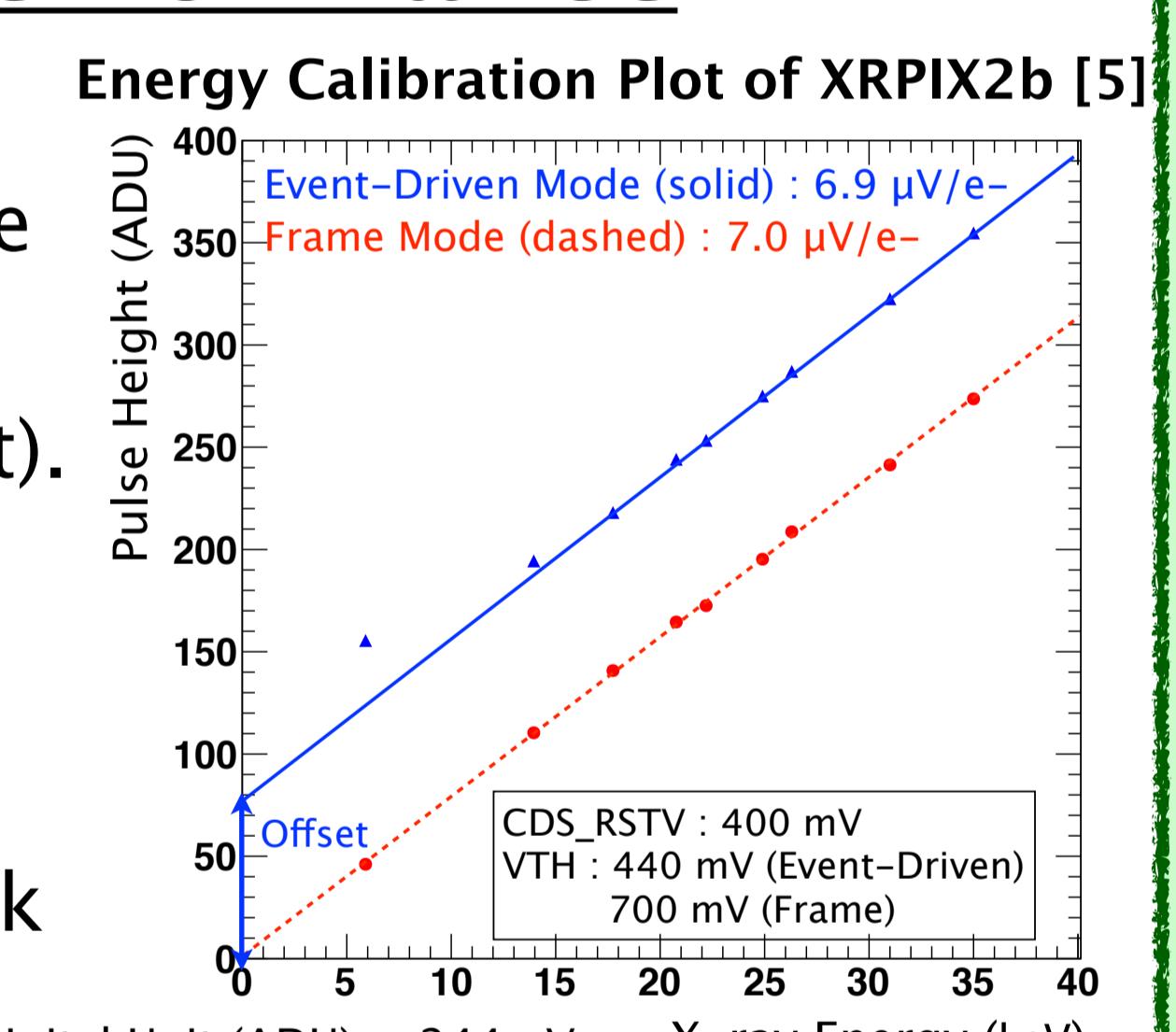
Improvement of spectroscopic performance

Our Previous Study

We showed the following issue in event-driven mode from our previous studies [5].

- Offset of pulse height to signal level (the right plot).
- Deterioration of spectroscopic performance.
(comparison of frame readout mode)

We concluded that the behavior of the comparator affects the analog CMOS circuit as electrical crosstalk to the sense-node.

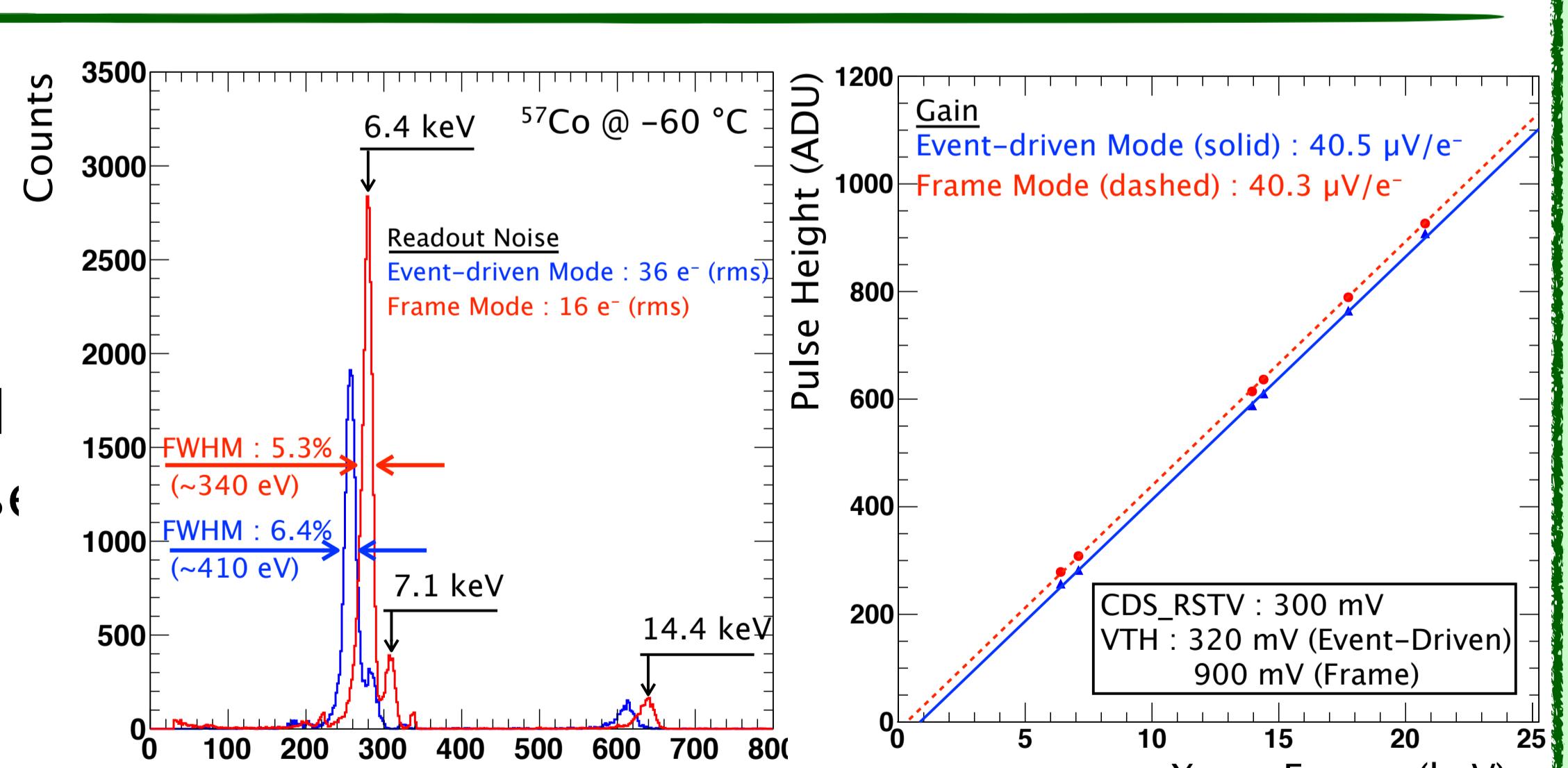


This Work

We evaluated and compared the frame and event-driven mode of XRPIX6D.

Compared with conventional our devices, the gain increase and the spectroscopic performance improved.

We observed suppression of the electrical crosstalk between the sense-node and CMOS circuit.



Calibration plot of X-ray energy and signal pulse height.

Summary

- We have been developing SOIPIX for future X-ray astronomical satellite mission.
- A new device, "XRPIX6D" was designed for improving spectroscopic performance.
-> Introduction of Double-SOI structure.
- We succeeded in improving the spectroscopic performance and suppressing the electrical crosstalk between sense-node and CMOS circuit by "XRPIX6D".
Frame -> ~ 340 eV (FWHM) @ 6.4 keV, Event-driven -> ~ 410 eV (FWHM) @ 6.4 keV

Reference

- [1] S.G.Ryu et. al., IEEE TNS., Vol.58, Issue:5, pp.2528–2536, 2011.
- [2] S.G.Ryu et. al., IEEE TNS., Vol.60, Issue:1 , pp.465–469, 2013.
- [3] S.Nakashima et. al., Phys. Procedia, Vol.37C, pp.1392–1399, 2013.
- [4] A.Takeda et. al., IEEE TNS., Vol.60, Issue:2, pp.586–591, 2013.
- [5] A.Takeda et. al., PoS (TIPP2014)138, 2014.
- [6] A.Takeda et. al., JINST., 10, C06005, 2015.